

Docket No.: H0498.70130US01

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Tao Deng

Serial No.:

10/763,819

Confirmation No.:

5026

Filed:

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For:

FABRICATION OF METALLIC MICROSTRUCTURES VIA

EXPOSURE OF PHOTOSENSITIVE COMPOSITION

Examiner:

K. Duda

Art Unit:

Dated:

1756

Certificate of Mailing Under 37 CFR 1.8(a)

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as First Class Mail, in an envelope addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

AFTER ALLOWANCE UNDER 37 C.F.R. §1.312

Mail Stop Issue Fee Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

Prior to issuance of the patent, applicant respectfully requests entry on this amendment under 37 C.F.R. 1.312 for the above-captioned patent application.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 6 of this paper.